#### 3.2x1.6mm, Infrared LED



## Round Subminiature Package Chip LED Infrared

# **Technical Data Sheet**

#### Features:

- Small double-end package
- Low forward voltage
- Good spectral matching to Si photo detector
- Package in 8mm tape on 7" diameter reel.
- Pb free
- The product itself will remain within RoHS compliant version.

#### **Descriptions:**

 SR160 is an infrared emitting diode in miniature SMD package which is molded in a water clear plastic with spherical top view lens. The device is spectrally matched with silicon photodiode and phototransistor

## **Applications:**

- Floppy disk drive.
- Optoelectronic switch.
- Camera.
- VCR.
- Video.
- Smoke detector.
- Infrared applied system.
- Free air transmission system.
- Infrared remote control units.

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Issue No.: G-Rev-4
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#### 3.2x1.6mm, Infrared LED

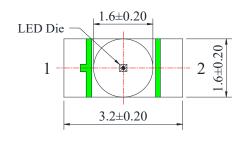


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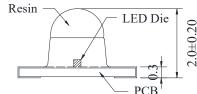
# **Technical Data Sheet**

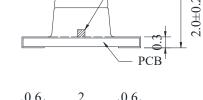
Part No.	<b>Emitting Color</b>	Lens Color	
SR160SIRC-1AX-T	Infrared	Water clear	

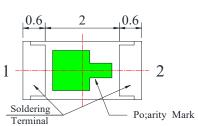
## **Package Dimension:**



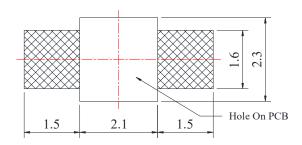








#### **Recommended Soldering Pad Dimensions**



#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ± 0.25 mm (.010") unless otherwise noted.

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## Round Subminiature Package Chip LED Infrared

# **Technical Data Sheet**

# Absolute Maximum Ratings at Ta=25℃

Parameters	Symbol	Max	Unit
Power Dissipation	Pd	100	mW
Peak Forward Current <sup>(a)</sup>	IFP	1000	mA
DC Forward Current <sup>(b)</sup>	IF	100	mA
Reverse Voltage	VR	5	V
Operating Temperature Range	Topr	-40°C to +85°C	
Storage Temperature Range	Tstg	-40°C to +85°C	
Soldering Temperature	Tsld	260℃ for 5 Seconds	

#### Notes:

## **Electrical Optical Characteristics at Ta=25℃**

Parameters	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Radiant Intensity	IE	2.0	10		mW/sr	IF=20mA
Viewing Anglet <sup>(a)</sup>	201/2		35		Deg	IF=20mA
Peak Emission Wavelength	λр		850		nm	IF=20mA
Spectral Bandwidth	$\triangle \lambda$		40		nm	IF=20mA
Forward Voltage	VF	1.00	1.45	1.80	V	IF=20mA
Reverse Current	IR			10	μΑ	V <sub>R</sub> =5V

Notes:

a. 201/2 is the o -axis angle where the luminous intensity is 1/2 the peak intensity

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a. Duty Factor = 10%, Frequency = 1 kHz

b. Derate linearly as shown in derating curve.

#### 3.2x1.6mm, Infrared LED

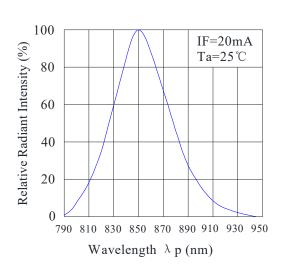
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## **Round Subminiature Package Chip LED Infrared**

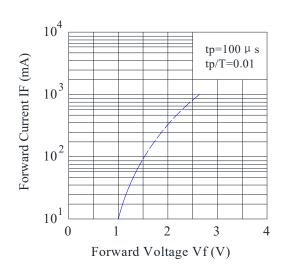
# **Technical Data Sheet**

# Typical Electrical / Optical Characteristics Curves (25℃ Ambient Temperature Unless Otherwise Noted)

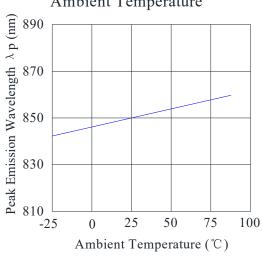
## Spectral Distribution



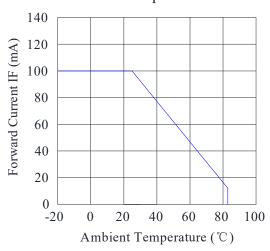
# Forward Current & Forward Voltage



Peak Emission Wavelength & Ambient Temperature



Forward Current & Ambient Temperature



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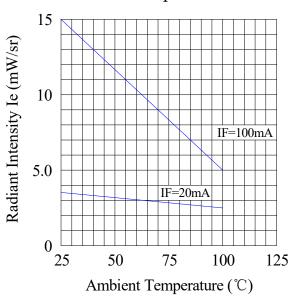
#### 3.2x1.6mm, Infrared LED

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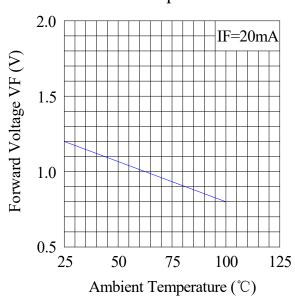
## **Round Subminiature Package Chip LED Infrared**

# **Technical Data Sheet**

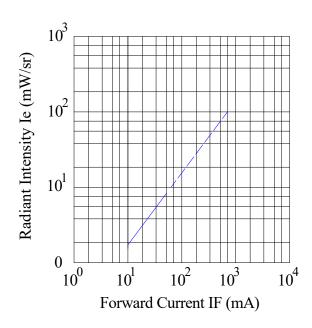
# Relative Intensity & Ambient Temperature



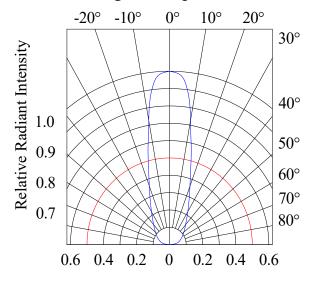
# Forward Voltage & Ambient Temperature



# Relative Intensity & Forward Current



# Relative Radiant Intensity & Angular Displacement



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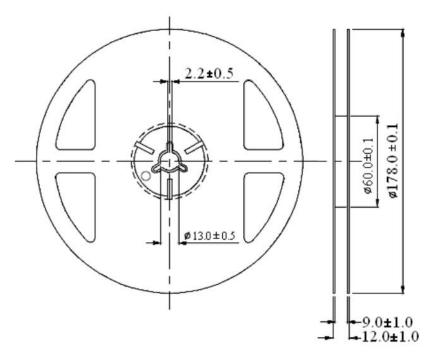
## 3.2x1.6mm, Infrared LED

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# Round Subminiature Package Chip LED Infrared

# **Technical Data Sheet**

#### **Reel Dimensions:**

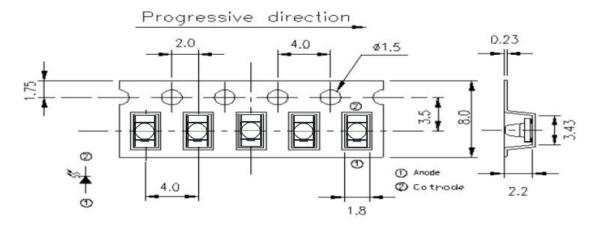


Unit: mm

Tolerance:  $\pm 0.25$ mm

## **Carrier Tape Dimensions:**

Loaded quantity 2000 pcs per reel.



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## 3.2x1.6mm, Infrared LED

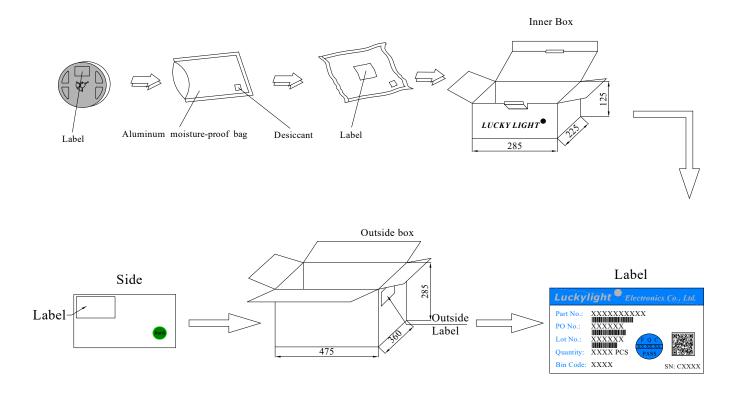
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# **Round Subminiature Package Chip LED Infrared**

# **Technical Data Sheet**

# Packing & Label Specifications:

#### Moisture Resistant Packaging:



#### **CAUTIONS**

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#### 3.2x1.6mm, Infrared LED

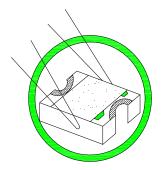


#### Round Subminiature Package Chip LED Infrared

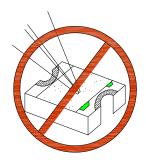
## **Technical Data Sheet**

#### 1. Handling Precautions:

- 1.1. Handle the component along the side surfaces by using forceps or appropriate tools.
- 1.2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.
- 1.3. Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry.









Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

#### 2. Storage

- 1.4. Do not open moisture proof bag before the products are ready to use.
- 1.5. Before opening the package, the LEDs should be kept at 30°C or less and 60%RH or less.
- 1.6. The LEDs should be used within a year.
- 1.7. After opening the package, the LEDs should be kept at 30°C or less and 60%RH or less.
- 1.8. The LEDs should be used within 168 hours after opening the package.
- 1.9. If the moisture adsorbent material has fabled away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment: 65±5°C for 24 hours.

#### 3. Soldering Condition

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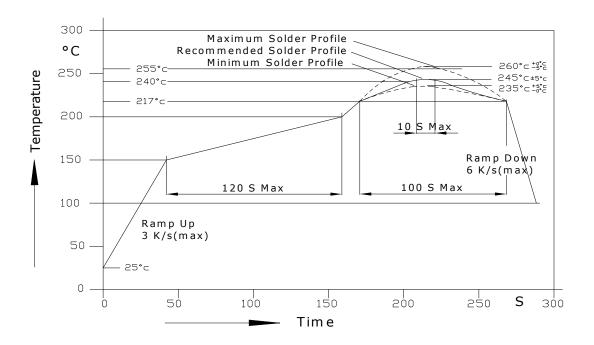
#### 3.2x1.6mm, Infrared LED



## Round Subminiature Package Chip LED Infrared

## **Technical Data Sheet**

#### 1.10. Pb-free solder temperature profile



- 1.11. Reflow soldering should not be done more than two times.
- 1.12. When soldering, do not put stress on the LEDs during heating.
- 1.13. After soldering, do not warp the circuit board.
- 1.14. Recommended soldering conditions:

Reflow soldering		Soldering iron		
Pre-heat	150~200°C	Temperature	300°C Max.	
Pre-heat time	120 sec. Max.	Soldering time	3 sec. Max.	
Peak temperature	260°C Max.		(one time only)	
Soldering time	10 sec. Max.(Max. two times)			

1.15. Because different board designs use different number and types of devices, solder pastes, reflow ovens, and circuit boards, no single temperature profile works for all possible combinations.

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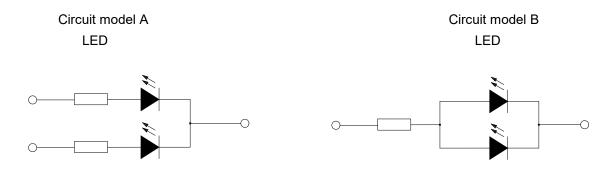
#### Round Subminiature Package Chip LED Infrared

#### **Technical Data Sheet**

However, you can successfully mount your packages to the PCB by following the proper guidelines and PCB-specific characterization.

#### **Drive Method**

1.16. An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.



a Recommended circuit.

bThe brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs.

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